Excellent Integrated System Limited

Stocking Distributor

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Sharp Microelectronics PC457L0NIP

For any questions, you can email us directly: sales@integrated-circuit.com

Distributor of Sharp Microelectronics: Excellent Integrated System Limited Datasheet of PC457L0NIP - PHOTOCOUPLER OPIC 5-SMD

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PC457L0NIP Series

PC457L0NIP **Series**

High Speed 1Mb/s, High CMR Mini-flat Package *OPIC Photocoupler



■ Description

PC457L0NIP Series contains a LED optically coupled to an OPIC chip.

It is packaged in a 5 pin Mini-flat. Input-output isolation voltage(rms) is 3.75 kV. High speed response (TYP. 1Mb/s) and CMR is MIN. 15 kV/μs.

■ Features

- 1. Mini-flat 5 pin package
- 2. Double transfer mold package (Ideal for Flow Soldering)
- 3. High speed response

(t_{PHL}: TYP. 0.2 μs, t_{PLH}: TYP. 0.4 μs)

4. High noise immunity due to high instantaneous common mode rejection voltage (CM_H: MIN. 15kV/μs,

 CM_L : MIN. $-15kV/\mu s$)

5. High isolation voltage between input and output $(V_{iso(rms)}: 3.75 \text{ kV})$

Notice The content of data sheet is subject to change without prior notice

■ Agency approvals/Compliance

- 1. Recognized by UL1577 (Double protection isolation), file No. E64380 (as model No. PC457L)
- 2. Approved by VDE (VDE0884) (as an option), file No. 5911UG (as model No. **PC457L**)
- 3. Package resin: UL flammability grade (94V-0)

■ Applications

- 1. Programmable controller
- 2. Inverter

Date Nov. 28. 2003 © SHARP Corporation

^{* &}quot;OPIC"(Optical IC) is a trademark of the SHARP Corporation. An OPIC consists of a light-detecting element and a signal-processing circuit integrated onto a single chip.

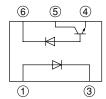
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PC457L0NIP Series

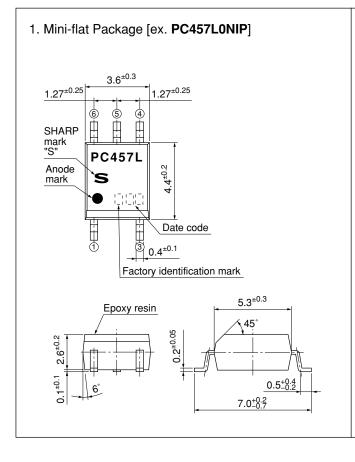
■ Internal Connection Diagram

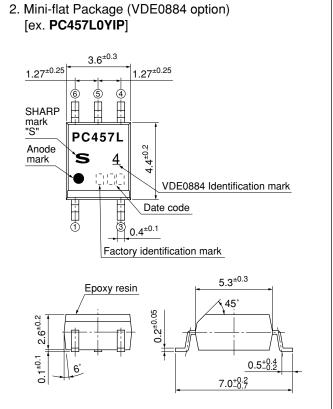


- ① Anode
- 3 Cathode
- 4 GND
- ⑤ Vo (Open collector)
- ⑥ V_{CC}

■ Outline Dimensions

(Unit:mm)





Product mass: approx. 0.1g

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PC457L0NIP Series

Date code (2 digit)

	1st o	digit		2nd digit		
	Year of p	roduction		Month of production		
A.D.	Mark	A.D	Mark	Month	Mark	
1990	A	2002	P	January	1	
1991	В	2003	R	February	2	
1992	С	2004	S	March	3	
1993	D	2005	T	April	4	
1994	Е	2006	U	May	5	
1995	F	2007	V	June	6	
1996	Н	2008	W	July	7	
1997	J	2009	X	August	8	
1998	K	2010	A	September	9	
1999	L	2011	В	October	0	
2000	M	2012	С	November	N	
2001	N	÷	:	December	D	

repeats in a 20 year cycle

Factory identification mark

Factory identification Mark	Country of origin	
no mark	Ionon	
	- Japan	
	Indonesia	
$\overline{\hspace{1cm}}$	Philippines	
	China	

^{*} This factory marking is for identification purpose only. Please contact the local SHARP sales representative to see the actual status of the production.

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PC457L0NIP Series

Absolute Maximum Ratings $(T_a=25^{\circ}C)$						
	Parameter	Symbol	Rating	Unit		
	*1 Forward current	I_{F}	25	mA		
Input	Reverse voltage	V_R	5	V		
	*2 Power dissipation	P	45	mW		
	Supply voltage	V _{CC}	-0.5 to +30	V		
Output	Output voltage	Vo	-0.5 to +20	V		
Output	Output current	Io	8	mA		
	*3 Power dissipation	Po	100	mW		
*3 Total power dissipation		P _{tot}	100	mW		
Operating temperature		Topr	-55 to +85	°C		
Storage temperature		T_{stg}	-55 to +125	°C		
*4 Isolation voltage		V _{iso (rms)}	3.75	kV		

^{*1} When ambient temperature goes above 70°C, the power dissipation goes down at

 T_{sol}

270

°C

*5 Soldering temperature

■ Electro-optical Characteristics*7

 $(T_a=25^{\circ}C)$

·						($I_a=25$ C)
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
	Forward voltage	$V_{\rm F}$	$I_F=16mA$	_	1.7	1.95	V
Input	Reverse current	I_R	$V_R=5V$	-	ı	10	μΑ
	Terminal capacitance	C_{t}	V=0, f=1MHz	-	60	250	pF
	High level output current (1)	I _{OH (1)}	$I_F=0, V_{CC}=5.5V, V_O=5.5V$	-	3	500	nA
	High level output current (2)	I _{OH (2)}	I O N 15N N 15N	_	-	1.0	μΑ
	*6 High level output current (3)	I _{OH (3)}	$I_F=0, V_{CC}=15V, V_0=15V$	_	-	50	μΑ
Output	High level supply current (1)	I _{CCH (1)}	I _E =0, V _{CC} =15V, V _O =OPEN	_	0.02	1.0	μΑ
	*6 High level supply current (2)	I _{CCH (2)}	$I_F=U$, $V_{CC}=13V$, $V_O=OPEN$	_	-	2.0	μΑ
	Low level supply current	I_{CCL}	$I_F=16\text{mA}, V_{CC}=15\text{V}, V_O=OPEN$	_	120	_	μΑ
	Low level output voltage	V _{OL}	$I_F=16mA$, $V_{CC}=4.5V$, $I_O=2.4mA$	_	-	0.4	V
	Current transfer ratio (1)	CTR (1)	$I_{F}=16mA, V_{CC}=4.5V,$	19	-	50	%
	*6 Current transfer ratio (2)	CTR (2)	V_O =0.4V, R_L =1.9k Ω	15	-	_	%
	Isolation resistance	R _{ISO}	DC500V, 40 to 60%RH	5×10 ¹⁰	10^{11}	_	Ω
	Floating capacitance	$C_{\rm f}$	V=0, f=1MHz	-	0.6	1.0	pF
Transfer charac-	"High→Low" propagation delay time	t _{PHL}	$I_F=16\text{mA}, V_{CC}=5V$	_	0.2	0.8	μs
charac-	"Low→High" propagation delay time	$t_{\rm PLH}$	$R_L=1.9\Omega$	_	0.4	0.8	μs
teristics	Instantaneous common mode rejection voltage (High level output)		$I_{F}\!\!=\!\!0,V_{CC}\!\!=\!\!5V,\\ V_{CM}\!\!=\!\!1.0kV_{(p\!-\!p)},R_{L}\!\!=\!\!1.9k\Omega$	15	30	_	kV/μs
	Instantaneous common mode rejection voltage (Low level output)	CM_L	$\begin{split} I_{F} = 16mA, V_{CC} = 5V, \\ V_{CM} = 1.0kV_{(p\text{-}p)}, R_{L} = 1.9k\Omega \end{split}$	-15	-30	_	kV/μs

^{*2} When ambient temperature goes above 70°C, the power dissipation goes down at 1.5mW/°C. (Fig.4)

^{*3} When ambient temperature goes above 70°C, the power dissipation goes down at 1.8mW/°C. (Fig.4) *4 40 to 60%RH, AC for 1minute, f=60Hz

^{*5} For 10s

^{*6} T_a =0 to 70°C *7 It shall connect a by-pass capacitor of $0.01\mu F$ or more between V_{CC} (pin **(G)**) and GND (pin **(4)**) near the device, when it measures transfer characteristics and the output side characteristics.



Datasheet of PC457L0NIP - PHOTOCOUPLER OPIC 5-SMD

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PC457L0NIP Series

■ Model Line-up

Doolrooo	Taping			
Package	3 000pcs/reel			
VDE0884		Approved		
Model No.	PC457L0NIP	PC457L0YIP		

Please contact a local SHARP sales representative to inquire about production status and Lead-Free options.



PC457L0NIP Series

Fig.1 Test Circuit for Propagation Delay Time

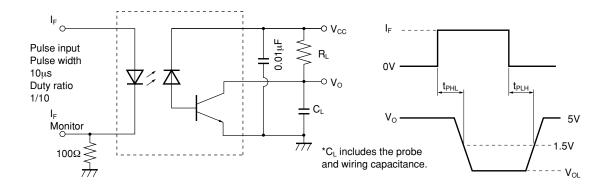


Fig.2 Test Circuit for Instantaneous Common Mode Rejection Voltage

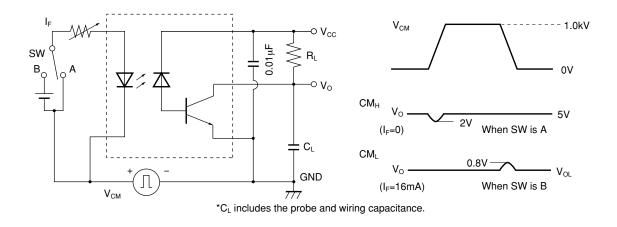


Fig.3 Forward Current vs. Ambient Temperature

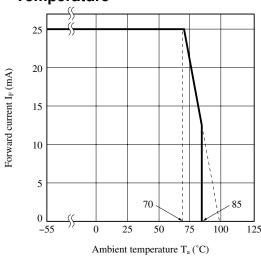


Fig.4 Power Dissipation vs. Ambient Temperature

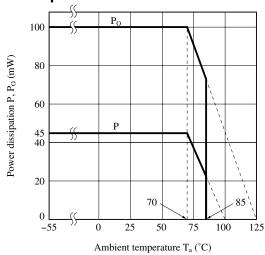






Fig.5 Forward Current vs. Forward Voltage

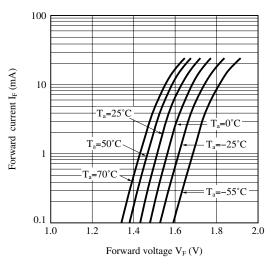


Fig.7 Output Current vs. Output Voltage

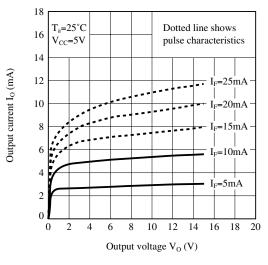


Fig.9 High Level Output Current vs.

Ambient Temperature

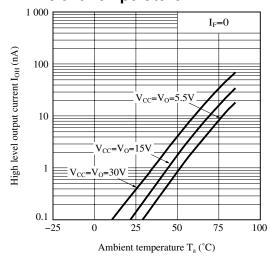


Fig.6 Relative Current Transfer Ratio vs. Forward Current

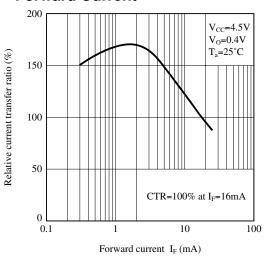


Fig.8 Relative Current Transfer Ratio vs.
Ambient Temperature

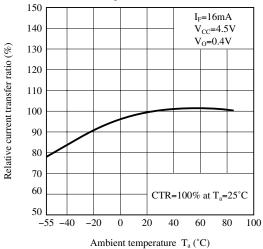
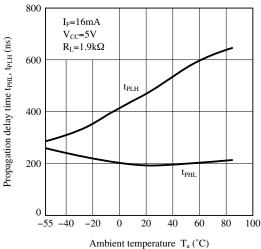


Fig.10 Propagation Delay Time vs. Ambient Temperature



Remarks: Please be aware that all data in the graph are just for reference and not for guarantee.

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PC457L0NIP Series

■ Design Considerations

Recommended operating conditions

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Input current	I_{F}	7	-	16	mA
Supply voltage	V_{CC}	-	5	-	V
Fan out (TTL load)	N	-	-	5	_
Operating temperature	Topr	0	ı	+70	°C

Notes about static electricity

Transistor of detector side in bipolar configuration may be damaged by static electricity due to its minute design.

When handling these devices, general countermeasure against static electricity should be taken to avoid breakdown of devices or degradation of characteristics.

Design guide

In order to stabilize power supply line, we should certainly recommend to connect a by-pass capacitor of $0.01\mu F$ or more between V_{CC} and GND near the device.

In case that some sudden big noise caused by voltage variation is provided between primary and secondary terminals of photocoupler some current caused by it is floating capacitance may be generated and result in false operation since current may go through LED or current may change.

If the photocoupler may be used under the circumstances where noise will be generated we recommend to use the bypass capacitors at the both ends of LED.

The detector which is used in this device, has parasitic diode between each pins and GND.

There are cases that miss operation or destruction possibly may be occurred if electric potential of any pin becomes below GND level even for instant.

Therefore it shall be recommended to design the circuit that electric potential of any pin does not become below GND level.

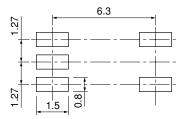
This product is not designed against irradiation and incorporates non-coherent LED.

Degradation

In general, the emission of the LED used in photocouplers will degrade over time.

In the case of long term operation, please take the general LED degradation (50% degradation over 5years) into the design consideration.

Recommended Foot Print (reference)



(Unit: mm)

☆ For additional design assistance, please review our corresponding Optoelectronic Application Notes.

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PC457L0NIP Series

■ Manufacturing Guidelines

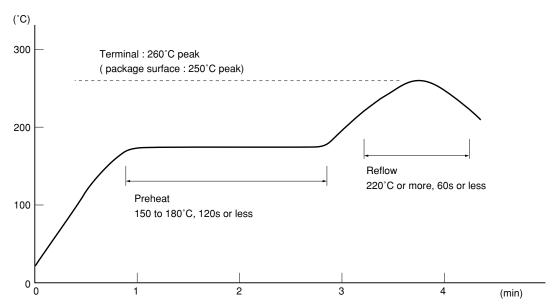
Soldering Method

Reflow Soldering:

Reflow soldering should follow the temperature profile shown below.

Soldering should not exceed the curve of temperature profile and time.

Please don't solder more than twice.



Flow Soldering:

Due to SHARP's double transfer mold construction submersion in flow solder bath is allowed under the below listed guidelines.

Flow soldering should be completed below 260°C and within 10s.

Preheating is within the bounds of 100 to 150°C and 30 to 80s.

Please don't solder more than twice.

Hand soldering

Hand soldering should be completed within 3s when the point of solder iron is below 400°C.

Please don't solder more than twice.

Other notices

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the tooling and soldering conditions.



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Cleaning instructions

Solvent cleaning:

Solvent temperature should be 45°C or below Immersion time should be 3minutes or less

Ultrasonic cleaning:

The impact on the device varies depending on the size of the cleaning bath, ultrasonic output, cleaning time, size of PCB and mounting method of the device.

Therefore, please make sure the device withstands the ultrasonic cleaning in actual conditions in advance of mass production.

Recommended solvent materials:

Ethyl alcohol, Methyl alcohol and Isopropyl alcohol

In case the other type of solvent materials are intended to be used, please make sure they work fine in actual using conditions since some materials may erode the packaging resin.

Presence of ODC

This product shall not contain the following materials.

And they are not used in the production process for this device.

Regulation substances : CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform)

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.



■ Package specification

● Tape and Reel package

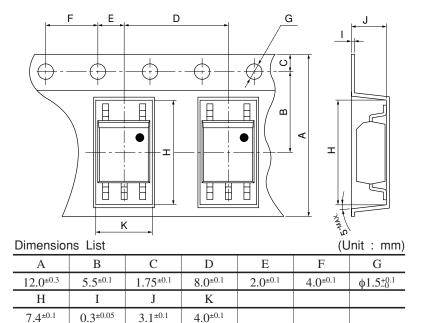
Package materials

Carrier tape: A-PET (with anti-static material)

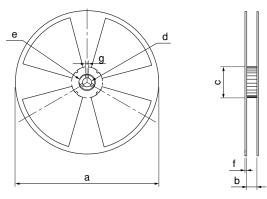
Cover tape: PET (three layer system)

Reel: PS

Carrier tape structure and Dimensions

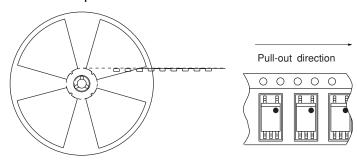


Reel structure and Dimensions



Dimensio	ns List	(Unit: mm)			
a	b	с	d		
370	13.5±1.5	80±1.0	13±0.5		
e	f	g			
21 ^{±1.0}	2.0 ^{±0.5}	2.0 ^{±0.5}			

Direction of product insertion



[Packing: 3 000pcs/reel]

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 - --- Office automation equipment
 - --- Telecommunication equipment [terminal]
 - --- Test and measurement equipment
 - --- Industrial control
 - --- Audio visual equipment
 - --- Consumer electronics
- (ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection

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- --- Traffic signals
- --- Gas leakage sensor breakers
- --- Alarm equipment
- --- Various safety devices, etc.
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